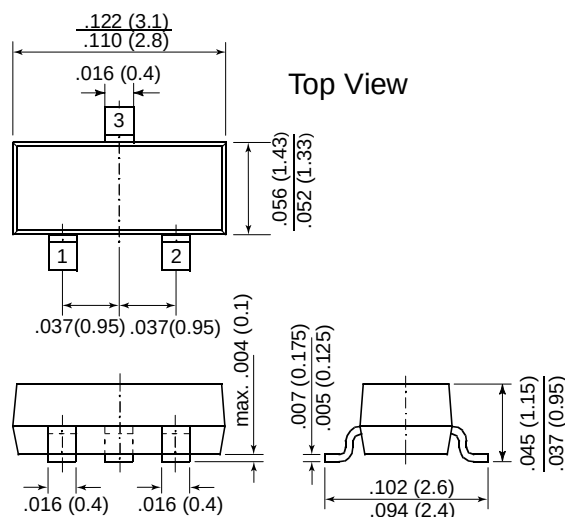




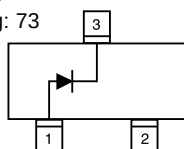
TO-236AB (SOT-23)



Dimensions in inches and (millimeters)

BAS70

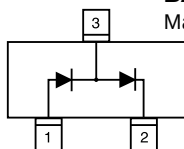
Marking: 73



Top View

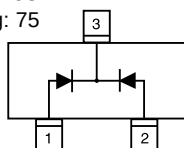
BAS70-04

Marking: 74



BAS70-05

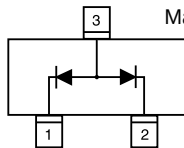
Marking: 75



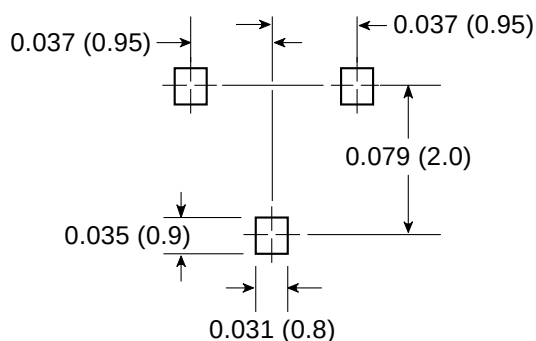
Top View

BAS70-06

Marking: 76



Mounting Pad Layout



Maximum Ratings and Thermal Characteristics (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	70	V
Forward Continuous Current at $T_{amb} = 25^{\circ}C$	I_F	200 ⁽¹⁾	mA
Surge Forward Current at $t_p < 1$ s, $T_{amb} = 25^{\circ}C$	I_{FSM}	600 ⁽¹⁾	mA
Power Dissipation ⁽¹⁾ at $T_{amb} = 25^{\circ}C$	P_{tot}	200 ⁽¹⁾	mW
Thermal Resistance Junction to Ambient Air	$R_{\theta JA}$	430 ⁽¹⁾	$^{\circ}C/W$
Junction Temperature	T_j	150	$^{\circ}C$
Storage Temperature Range	T_S	-55 to +150	$^{\circ}C$

Note:

(1) Device on fiberglass substrate, see layout on next page.

Features

- These diodes feature very low turn-on voltage and fast switching.
- These devices are protected by a PN junction guard ring against excessive voltage, such as electrostatic discharges.

Mechanical Data

Case: SOT-23 Plastic Package

Weight: approx. 0.008g

Packaging Codes/Options:

E8/10K per 13" reel (8mm tape), 30K/box

E9/3K per 7" reel (8mm tape), 30K/box

Schottky Diodes

Electrical Characteristics (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Breakdown Voltage	$V_{(BR)R}$	$I_R = 10\mu A$ (pulsed)	70	—	—	V
Leakage Current	I_R	Pulse Test $t_p < 300\mu s$ $V_R = 50V$	—	20	100	nA
Forward Voltage	V_F	Pulse Test $t_p < 300\mu s$ $I_F = 1mA$ $I_F = 15mA$	— —	— —	410 1000	mV mV
Capacitance	C_{tot}	$V_R = 0V$ $f = 1MHz$	—	1.5	2	pF
Reverse Recovery Time	t_{rr}	$I_F = 10mA, I_R = 10mA$ $I_{rr} = 1mA, R_L = 100\Omega$	—	—	5	ns

Note:

(1) Device on fiberglass substrate, see layout.

Layout for R_{θJA} test

Thickness: Fiberglass 0.059 in. (1.5 mm)
Copper leads 0.012 in. (0.3 mm)

